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Part Number: L-73EB/2IDA   High Efficiency Red

Features

● Pre-trimmed leads for pc board mounting.

● Colors can be mixed in a single housing.

● Black case enhances contrast ratio.

● Wide viewing angle.

● High reliability - life measured in years.

● Housing UL rating:94V-0.

● Housing material: type 66 nylon.

● RoHS compliant.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions

RECOMMENDED PCB LAYOUT
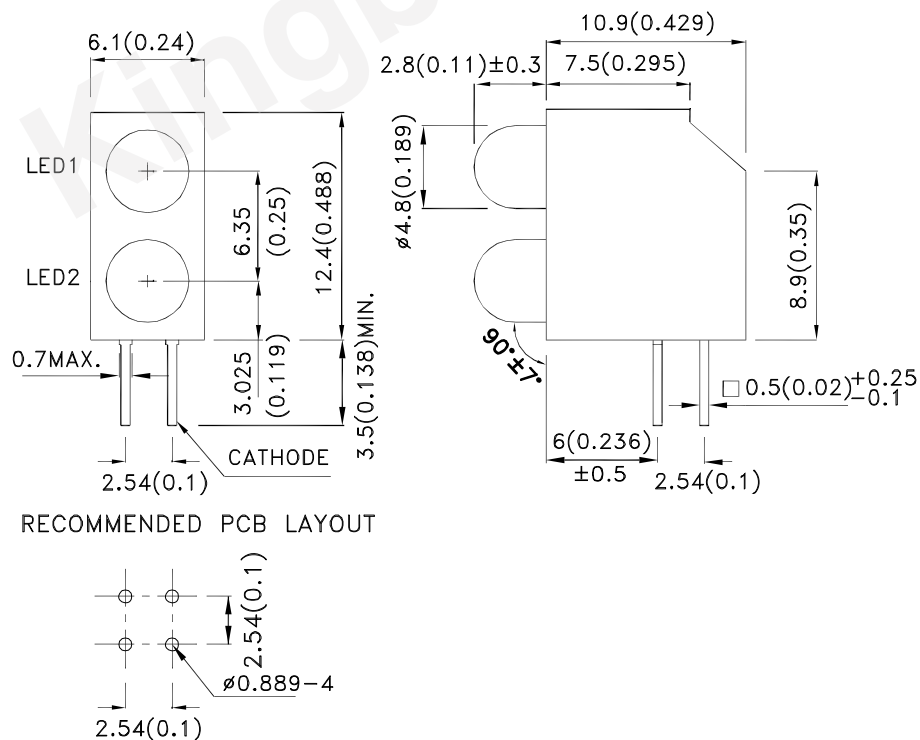
Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 10mA Min.	Iv (mcd) [2] @ 10mA Typ.	Viewing Angle [1] 2θ1/2
L-73EB/2IDA	High Efficiency Red (GaAsP/GaP)	Red Diffused	15	40	60°
			*8	*20	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
 *Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

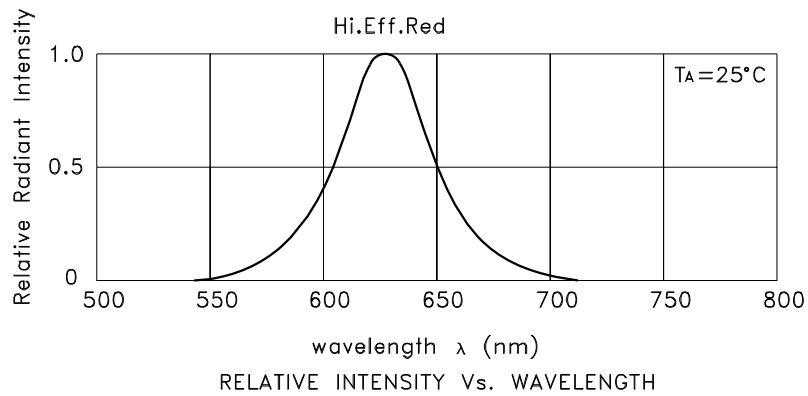| Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627		nm	I_F=20mA
λD [1]	Dominant Wavelength	High Efficiency Red	617		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red	45		nm	I_F=20mA
C	Capacitance	High Efficiency Red	15		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	High Efficiency Red	2	2.5	V	I_F=20mA
I_R	Reverse Current	High Efficiency Red		10	uA	V_R = 5V

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
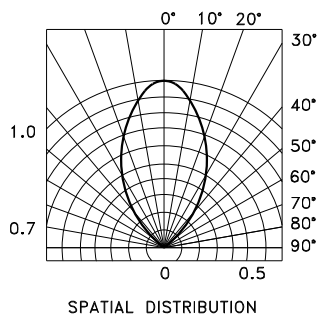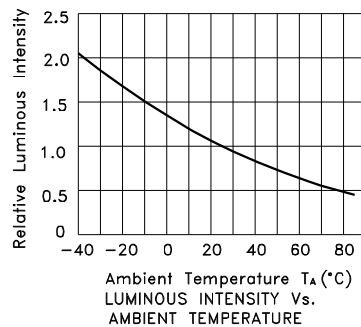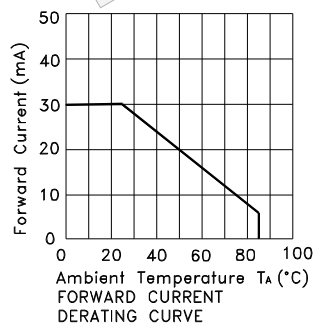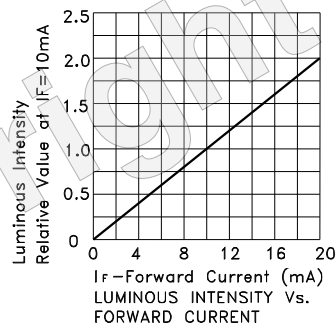
Absolute Maximum Ratings at TA=25°C

Parameter	High Efficiency Red	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	160	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	
Lead Solder Temperature [2]	260°C For 3 Seconds	
Lead Solder Temperature [3]	260°C For 5 Seconds	

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
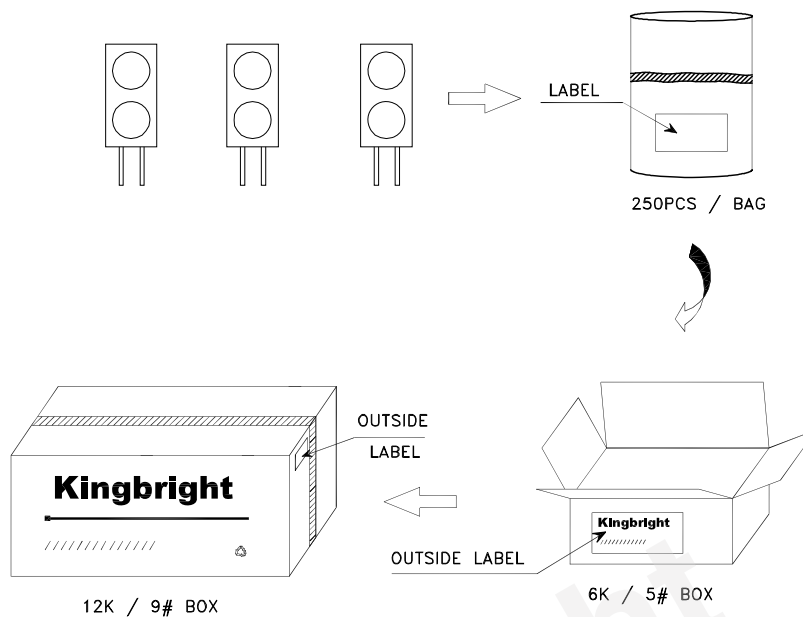3. 5mm below package base.

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Hi.Eff.Red

$T_A = 25°C$

RELATIVE INTENSITY Vs. WAVELENGTH

High Efficiency Red   L-73EB/2IDA

FORWARD CURRENT Vs.
FORWARD VOLTAGE

LUMINOUS INTENSITY Vs.
FORWARD CURRENT

FORWARD CURRENT
DERATING CURVE

LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

SPATIAL DISTRIBUTION
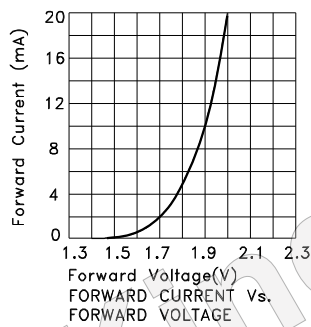
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PACKING & LABEL SPECIFICATIONS   **L-73EB/2IDA**

LABEL

250PCS / BAG

OUTSIDE LABEL

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OUTSIDE LABEL

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12K / 9# BOX   6K / 5# BOX

Kingbright

P/NO: L-73EBxxx

QTY: 250 pcs   Q.C.

S/N: XXXX

CODE: XXX

LOT NO:

Q C
XX XX XXXX
PASSED

xxxxxxxxxxxxxxxxxxxxxxx

RoHS Compliant

Terms and conditions for the usage of this document

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.

2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.

3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

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6. All design applications should refer to Kingbright application notes available at http://www.kingbright.com/application_notes

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PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead   forming procedures.
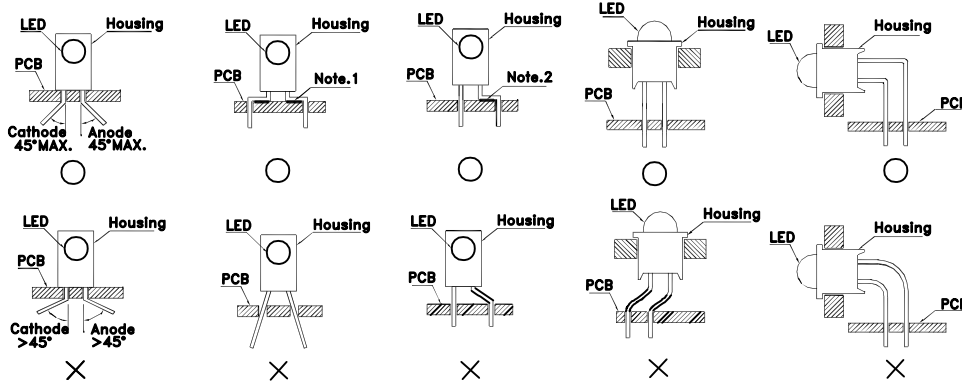
" ◯ "   Correct mounting method   " ✕ "   Incorrect mounting method

2. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.

3. The tip of the soldering iron should never touch the lens epoxy.
4. Through—hole LEDs are incompatible with reflow soldering.
5. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
6. Recommended Wave Soldering Profiles:
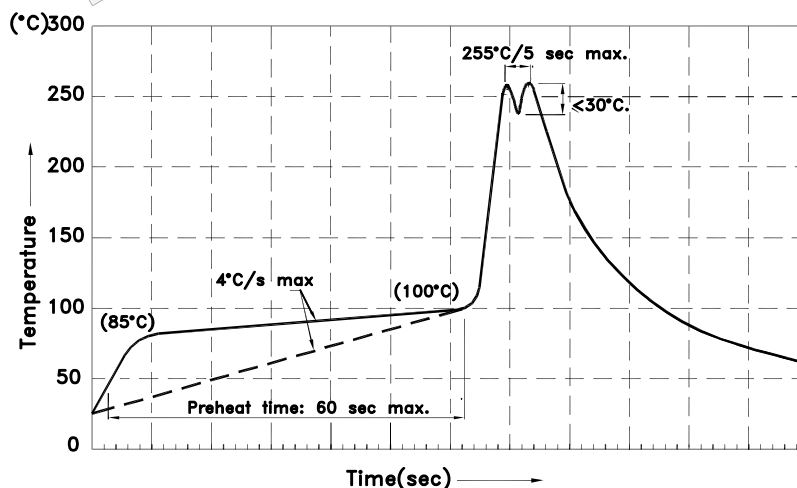
Notes:
1. Recommend pre—heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.